



DCR2560A85

Phase Control Thyristor

Replaces DS5932-3 DS5932-4 March 2022 (LN41632)

FEATURES

- Double Side Cooling
- High Surge Capability

APPLICATIONS

- Bridge Rectifiers
- High Power Drives
- High Voltage Power Supplies
- Static Switches

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages VDRM and VRRM (V)	Conditions
		T _{vj} = -40°C to 125°C,
DCR2560A85*	8500	IDRM = IRRM = 300mA,
DCR2560A80	8000	VDRM, VRRM tp = 10ms
DCR2560A75	7500	VDSM & VRSM =
DCR2560A70	7000	VDRM & VRRM + 100V
		respectively

Lower voltage grades available.

KEY PARAMETERS

V_{DRM}	8500V
I _{T(AV)}	2610A
Ітѕм	34500A
dV/dt*	1500V/µs
dl/dt	200A/μs

^{*} Higher dV/dt selections are available on request

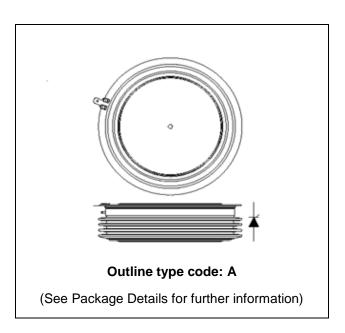


Fig. 1 Package outline

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR2560A85

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

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^{*8200}V @ -40°C, 8500V @ 0°C



CURRENT RATINGS

T_{case} = 60°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Side Cooled				
İT(AV)	Mean on-state current	Half wave resistive load	2610	А
It(RMS)	RMS value	-	4100	Α
lτ	Continuous (direct) on-state current	-	3790	А

SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
Ітѕм	Surge (non-repetitive) on-state current	10ms half sine, Tcase = 125°C	34.5	kA
l²t	I2t for fusing	V _R = 0	5.95	MA ² s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
		Double side cooled	DC	-	6.0	°C/kW
Rth(j-c)	Thermal resistance - junction to case	Cingle side socied	Anode DC	-	10.4	°C/kW
		Single side cooled	Cathode DC	-	14.9	°C/kW
D ate 13	Rth(c-h) Thermal resistance - case to heatsink	Clamping force 83kN	Double side	-	1.0	°C/kW
Ktn(c-n)		(with mounting compound)	Single side	-	2.0	°C/kW
Tvj	Virtual junction temperature	Blocking VDRM / VRRM		-	125	°C
Tstg	Storage temperature range			-55	125	°C
Fm	Clamping force			74	91	kN

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DYNAMIC CHARACTERISTICS

Symbol Parameter		Test Conditions		Max.	Units
IRRM/IDRM	Dook rovered and off state overent	At VRRM/VDRM, Tcase = 125°C		300	mA
	Peak reverse and off-state current	At 50% VRRM/VDRM, Tcase = 125°C	30	-	mA

Symbol	Parameter	Test Condition	ıs	Min.	Max.	Units
Vтм	Instantaneous forward voltage	At 4000A peak, Tj = 125°C		2.65	2.95	V
dV/dt	Max. linear rate of rise of off-state voltage	To 67% VdRM, Tj = 125°C, g	ate open	-	1500	V/µs
dl/dt	Rate of rise of on-state current	From 67% VDRM to 2x IT(AV)	Repetitive 50Hz	-	100	A/µs
di/dt	Rate of fise of on-state current	Gate source 30V, 10Ω tr < 0.5 μ s, Tj = 125°C	Non-repetitive	-	200	A/µs
V T(TO)	Threshold voltage - Low level	500A to 3200A at Tcase = 1	25°C	-	1.24	٧
V T(TO)	Threshold voltage - High level	3200A to 9000A at Tcase = 125°C		-	1.43	V
	On-state slope resistance - Low level	500A to 3200A at Tcase = 125°C		-	0.44	mΩ
ľτ	On-state slope resistance - High level	3200A to 9000A at Tcase = 125°C		-	0.38	mΩ
tgd	Delay time	$V_D=67\%$ V_{DRM} , gate source 30V, 10Ω $t_T=0.5\mu s$, $T_J=25^{\circ}C$		-	3	μs
tq	Turn-off time	Iτ = 3000A, Tj = 125°C, VR = 200V, dl/dt = 1A/μs, dV _{DR} /dt = 20V/μs linear		-	1000	μs
Qs	Stored charge	Iτ = 2000A, Tj = 125°C, dl/dt = 1A/μs		5150	7240	μC
IRR	Reverse recovery current	$V_R \sim 3400V$, $C_S = 1.5 \mu F$, $R_S = 63 \Omega$		57	68	Α
lι	Latching current	Tj = 25°C, VD = 5V		-	3	А
Ін	Holding current	Tj = 25°C, Rg-κ = ∞, Iτм = 500A, Iτ = 5A		-	300	mA

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GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
V GT	Gate trigger voltage	VDRM = 5V, Tcase = 25°C	1.5	٧
V GD	Gate non-trigger voltage	At 50% VDRM, Tcase = 125°C	0.4	V
Ідт	Gate trigger current	VDRM = 5V, Tcase = 25°C	400	mA
lgp	Gate non-trigger current	At 50% VDRM, Tcase = 125°C	10	mA

CURVES

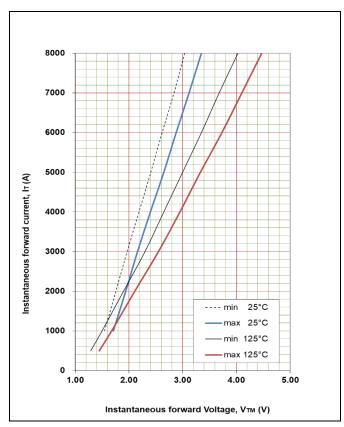


Fig. 2 Maximum & minimum on-state characteristics

VTM EQUATION

 $V_{TM} = A + B.ln(I_T) + C.I_T + D.\sqrt{I_T}$

Where A = -0.047872

B = 0.229354

C = 0.000394

D = -0.007695

These values are valid for $T_j = 125$ °C for $I_T 500A$ to 9000A

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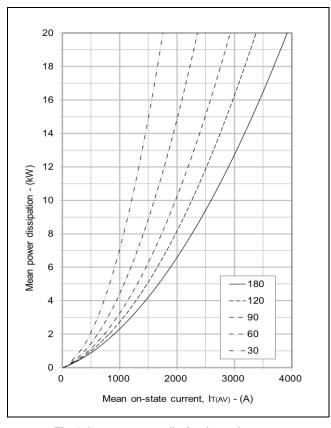


Fig. 3 On-state power dissipation - sine wave

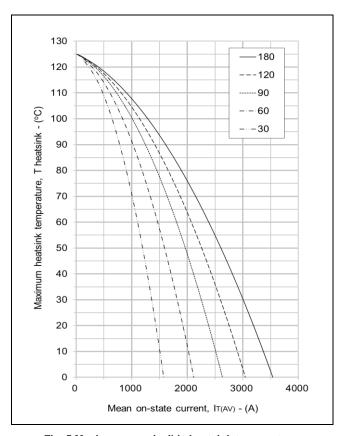


Fig. 5 Maximum permissible heatsink temperature, double side cooled - sine wave

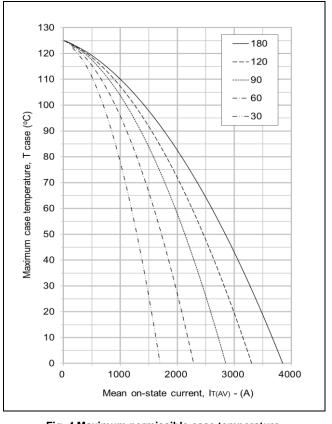


Fig. 4 Maximum permissible case temperature, double side cooled - sine wave

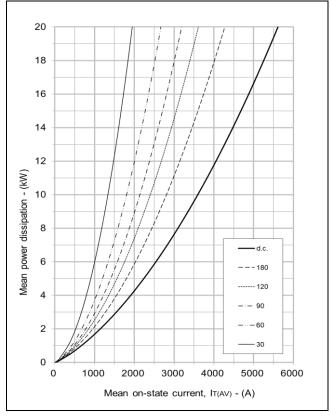


Fig. 6 On-state power dissipation - rectangular wave

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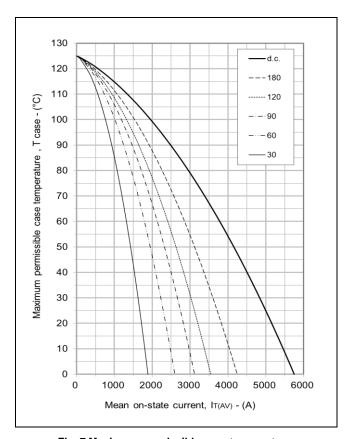
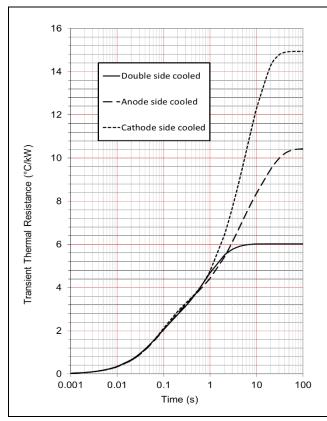


Fig. 7 Maximum permissible case temperature, double side cooled - rectangular wave



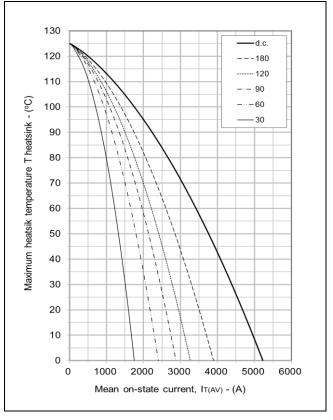


Fig. 8 Maximum permissible heatsink temperature, double side cooled - rectangular wave

		1	2	3	4
Double side	Ri(°C/kW)	3.015	1.049	0.984	0.984
cooled	Ti(s)	0.704	1.905	0.059	0.059
Anode side cooled	Ri(°C/kW)	3.156	4.093	1.557	1.624
	Ti(s)	2.690	13.792	0.059	0.206
Cathode side	Ri(°C/kW)	7.077	3.483	1.746	2.634
cooled	Ti(s)	6.649	8.436	1.762	0.081

$$Z_{th} = \sum_{i=1}^{i=4} R_i \cdot \left(1 - \exp\left(-\frac{T}{T_i}\right)\right)$$

 $\Delta R_{\text{th(j-c)}}$ Conduction

Tables show the increments of thermal resistance R $_{\text{th}(j-c)}$ when the device operates at conduction angles other than d.c.

Do	Double side cooling			
	ΔZ_{th}	(z)		
θ°	sine. rect.			
180	0.44	0.31		
120	0.49	0.43		
90	0.55	0.49		
60	0.60	0.55		
30	0.64	0.61		
15	0.66	0.64		

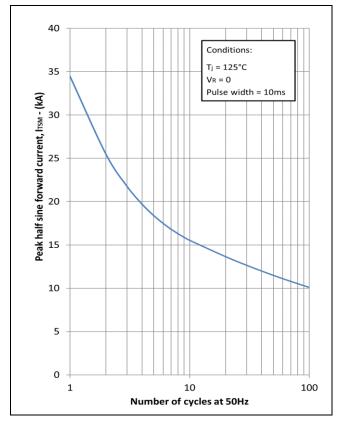
Ar	node Side Cooling		
	ΔZ_{th} (z)		
θ° sine.		rect.	
180	0.42	0.30	
120	0.47	0.41	
90	0.52	0.46	
60	0.57	0.52	
30	0.61	0.58	
15	0.62	0.61	

Cathode Sided Cooling				
	ΔZ	$\Delta Z_{th}(z)$		
θ°	sine.	rect.		
180	0.42	0.30		
120	0.47	0.41		
90	0.52	0.46		
60	0.57	0.52		
30	0.60	0.58		
15	0.62	0.60		

Fig.9 Maximum (limit) transient thermal impedance - junction to case (degC/kW)

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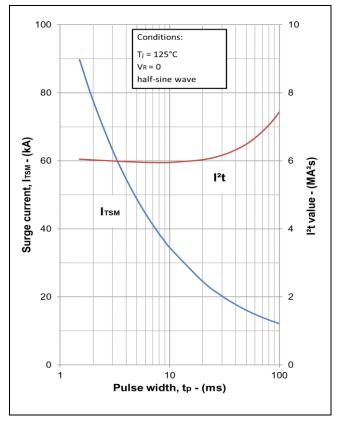


Fig. 10 Multi-cycle surge current

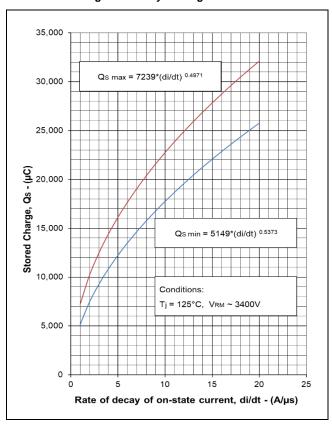


Fig. 12 Stored charge

Fig. 11 Single-cycle surge current

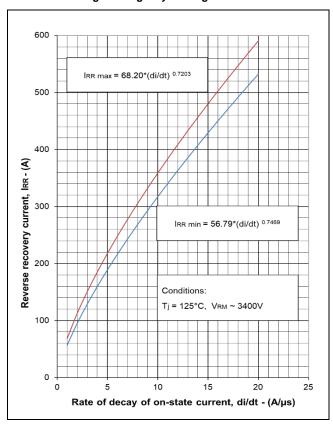


Fig. 13 Reverse recovery current

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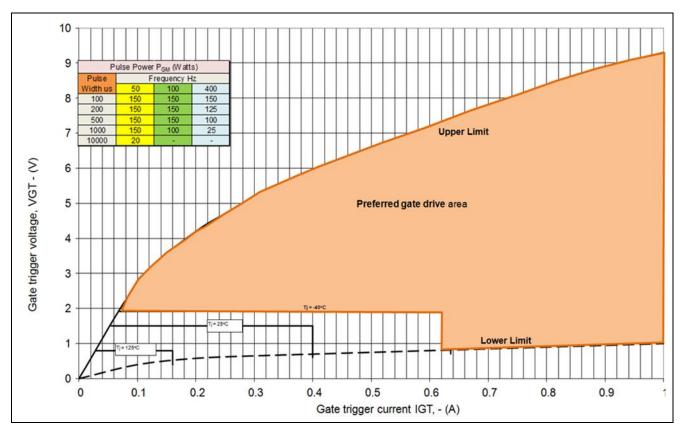


Fig.14 Gate characteristics

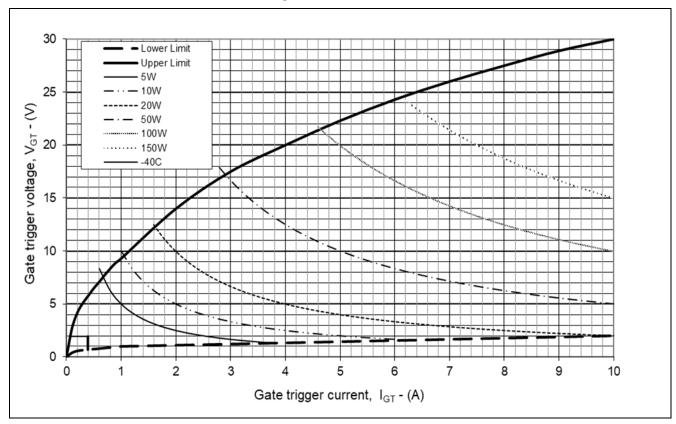


Fig. 15 Gate characteristics

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PACKAGE DETAILS

For further package information, please contact Customer services.

All dimensions in mm, unless stated otherwise.

DO NOT SCALE

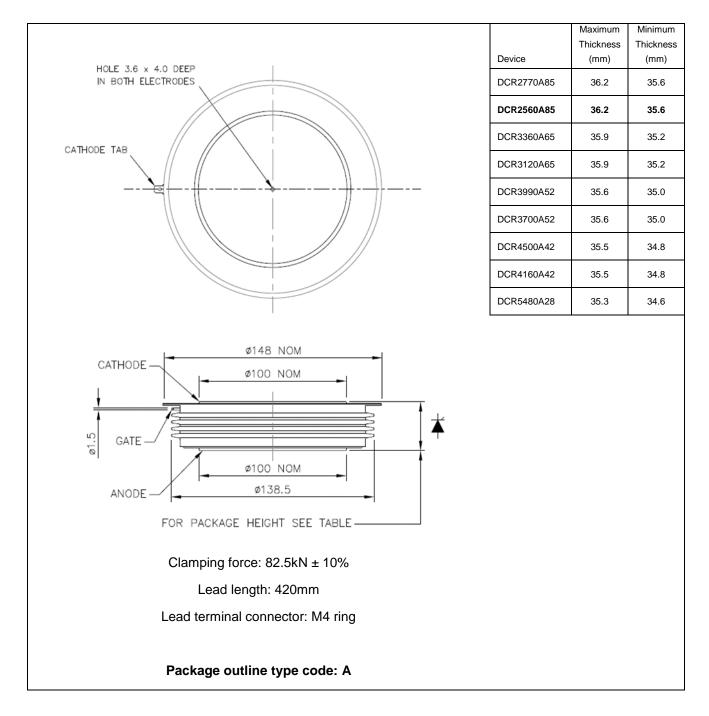


Fig. 16 Package outline

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